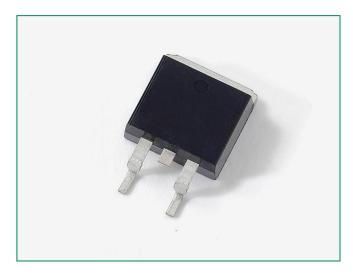


NGB8206AN - 20 A, 350 V, N-Channel Ignition IGBT, D²PAK





20 Amps, 350 Volts $V_{re}(on) \le 1.3 \text{ V } @$ $I_{\text{C}} = 10\text{A, V}_{\text{GE}} \ge 4.5\text{ V}$

Maximum Ratings (T₁ = 25°C unless otherwise noted)

| Rating | Symbol | Value | Unit |
|---|-----------------------------------|----------------|-----------------|
| Collector-Emitter Voltage | V _{CES} | 390 | V |
| Collector-Gate Voltage | V _{CER} | 390 | V |
| Gate-Emitter Voltage | V _{GE} | ±15 | V |
| Collector Current-Continuous @T _c = 25°C - Pulsed | I _c | 20 50 | A _{DC} |
| Continuous Gate Current | l _G | 1.0 | mA |
| Transient Gate Current (t \leq 2 ms, f \leq 100 Hz) | l _G | 20 | mA |
| ESD (Charged-Device Model) | ESD | 2.0 | kV |
| ESD (Human Body Model) R = 1500 Ω , C = 100 pF | ESD | 8.0 | kV |
| ESD (Machine Model) R = 0 Ω, C = 200 pF | ESD | 500 | V |
| Total Power Dissipation @T _c = 25°C Derate above 25°C | P _D | 150 1.0 | Watts W/°C |
| Operating and Storage Temperature Range | T _J , T _{stg} | -55 to +175 | °C |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Description

This Logic Level Insulated Gate Bipolar Transistor (IGBT) features monolithic circuitry integrating ESD and Over-Voltage clamped protection for use in inductive coil drivers applications. Primary uses include Ignition, Direct Fuel Injection, or wherever high voltage and high current switching is required.

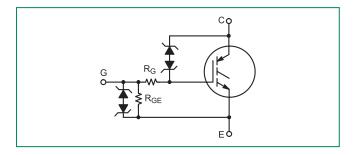
Features

- Ideal for Coil-on-Plug and Driver-on-Coil Applications
- Gate-Emitter ESD Protection
- Temperature Compensated Gate-Collector Voltage Clamp Limits Stress Applied to Load
- Integrated ESD Diode Protection
- Low Threshold Voltage for Interfacing Power Loads to Logic or Microprocessor Devices
- Low Saturation Voltage
- High Pulsed Current Capability
- These are Pb-Free Devices

Applications

• Ignition Systems

Functional Diagram



Additional Information









Samples



Unclamped Collector–To–Emitter Avalanche Characteristics (–55 $^{\circ}$ \leq T $_{\rm J}$ \leq 175 $^{\circ}$ C)

| | Symbol | Value | Unit |
|--|--------------------|-------|------|
| Single Pulse Collector-to-Emitter Avalanche Energy | | | |
| $V_{CC} = 50 \text{ V}, V_{GE} = 5.0 \text{ V}, P_k I_L = 16.7 \text{ A}, R_G = 1000 \Omega, L = 1.8 \text{ mH}, Starting T_J = 25 ^{\circ}\text{C}$ | | 250 | |
| $V_{CC} = 50 \text{ V}, V_{GE} = 5.0 \text{ V}, P_k I_L = 14.9 \text{ A}, R_G = 1000 \Omega, L = 1.8 \text{ mH}, Starting T_J = 150 °C$ | E _{AS} | 200 | mJ |
| $V_{CC} = 50 \text{ V}, V_{GE} = 5.0 \text{ V}, P_k I_L = 14.1 \text{ A}, R_G = 1000 \Omega, L = 1.8 \text{ mH}, Starting T_J = 175°C$ | | 180 | |
| Reverse Avalanche Energy | | | |
| $V_{CC} = 100 \text{ V}, V_{GE} = 20 \text{ V}, P_k I_L = 25.8 \text{ A}, L = 6.0 \text{ mH}, \text{ Starting T}_J = 25^{\circ}\text{C}$ | E _{AS(R)} | 2000 | mJ |

^{1.} When surface mounted to an FR4 board using the minimum recommended pad size.

Thermal Characteristics

| Rating | Symbol | Value | Unit |
|---|------------------|-------|------|
| Thermal Resistance, Junction to Case | R _{eJC} | 1.0 | °C/W |
| Thermal Resistance, Junction to Ambient (Note 1) | $R_{\theta JA}$ | 62.5 | °C/W |
| Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 seconds | T _L | 275 | °C |



Electrical Characteristics - OFF

| Characteristic | Symbol | Test Conditions | Temperature | Min | Тур | Max | Unit |
|--|----------------------|---|--|-------|------|------|------|
| Collector-Emitter | D\/ | $I_{c} = 2.0 \text{ mA}$ | $T_J = -40$ °C to 150°C | 325 | 350 | 375 | V |
| Clamp Voltage | BV _{ces} | $I_{\rm C}$ = 10 mA | $T_J = -40$ °C to 150°C | 340 | 365 | 390 | V |
| | | $V_{CE} = 15 \text{ V},$ $V_{GE} = 0 \text{ V},$ | T _J = 25°C | _ | 0.1 | 1.0 | |
| Zero Gate Voltage | l _{CES} | | T _J = 25°C | 0.5 | 1.5 | 10 | μΑ |
| Collector Current | CES | $V_{CE} = 175V$ $V_{GF} = 0 V$ | T _J = 175°C | 1.0 | 25 | 100* | |
| | | | T _J = -40°C | 0.4 | 0.8 | 5.0 | |
| | | | T _J = 25°C | 30 | 35 | 39 | |
| Reverse Collector–Emitter Clamp Voltage | BV _{CES(R)} | $I_{c} = -75 \text{ mA}$ | T _J = 175°C | 32 | 37 | 42 | V |
| | | | T _J = -40°C | 29 | 32 | 37 | |
| | | | T _J = 25°C | 0.05 | 0.25 | 1.0 | |
| Reverse Collector–Emitter Leakage Current | I _{CES(R)} | $V_{CE} = -24 V$ | T _J = 175°C | 1.0 | 12.5 | 25 | mA |
| | | | T _J = -40°C | 0.005 | 0.03 | 0.25 | |
| Gate-Emitter Clamp Voltage | BV _{GES} | I _G = ±5.0 mA | $T_{J} = -40^{\circ}\text{C to}$ 175°C | 12 | 12.5 | 14 | V |
| Gate-Emitter Leakage Current | I _{GES} | $V_{GE} = \pm 5.0 V$ | $T_{J} = -40^{\circ}\text{C to}$ 175°C | 200 | 300 | 350* | μА |
| Gate Resistor | $R_{\rm G}$ | - | $T_{J} = -40^{\circ}\text{C to}$ 175°C | - | - | - | Ω |
| Gate Emitter Resistor | R _{GE} | - | T _J = -40°C to 175°C | 14.25 | 16 | 25 | kΩ |

Electrical Characteristics - ON (Note 3)

| Characteristic | Symbol | Test Conditions | Temperature | Min | Тур | Max | Unit |
|---|---------------------|---------------------------|------------------------|-----|-----|------|-------|
| | | | T _J = 25°C | 1.5 | 1.8 | 2.1 | |
| Gate Threshold Voltage | V _{GE(th)} | $I_{c} = 1.0 \text{ mA},$ | T _J = 175°C | 0.7 | 1.0 | 1.3 | V |
| | | $V_{GE} = V_{CE}$ | T _J = -40°C | 1.7 | 2.0 | 2.3* | |
| Threshold Temperature Coefficient (Negative) | - | - | - | 3.8 | 4.6 | 6.0 | mV/°C |

 $^{{\}rm *Maximum\,Value\,\,of\,\,Characteristic\,\,across\,Temperature\,\,Range}.$

^{3.} Pulse Test: Pulse Width $\leq 300~\mu\text{S},~\text{Duty Cycle} \leq 2\,\%$.



Electrical Characteristics - ON (Note 4)

| Characteristic | Symbol | Test Conditions | Temperature | Min | Тур | Max | Unit | | | | | | | |
|---------------------------------|----------------------|---|------------------------|-----------------------|-------------------------|-------------------------|-------------------------|--|-------------------------|------------------------|-----|------|-----|--|
| | | | T _J = 25°C | 0.95 | 1.15 | 1.35 | | | | | | | | |
| | | $I_{c} = 6.5 \text{ A},$ $V_{ge} = 3.7 \text{ V}$ | T _J = 175°C | 0.70 | 0.95 | 1.15 | | | | | | | | |
| | | V GE − 0.7 V | T _J = -40°C | 1.0 | 1.30 | 1.40 | | | | | | | | |
| | | | T _J = 25°C | 0.95 | 1.25 | 1.45 | | | | | | | | |
| | | $I_{c} = 9.0 \text{ A},$ $V_{ge} = 3.9 \text{ V}$ | T _J = 175°C | 0.8 | 1.05 | 1.25 | | | | | | | | |
| | | v _{GE} = 0.5 v | T _J = -40°C | 1.1 | 1.4 | 1.50 | | | | | | | | |
| | | | T _J = 25°C | 0.85 | 1.15 | 1.4 | | | | | | | | |
| | V _{CE (on)} | $I_{c} = 7.5 \text{ A},$ $V_{GE} = 4.5 \text{ V}$ | T _J = 175°C | 0.7 | 0.95 | 1.2 | | | | | | | | |
| Callegia to Facility | | V _{CE (on)} | | | v _{GE} – 4.5 v | T _J = -40°C | 1.0 | 1.3 | 1.6* | | | | | |
| Collector-to-Emitter On-Voltage | | | | T _J = 25°C | 0.9 | 1.2 | 1.6 | V | | | | | | |
| | | | | | | $I_{c} = 10 \text{ A},$ | $I_{c} = 10 \text{ A},$ | $I_c = 10 \text{ A},$ $V_{GE} = 4.5 \text{ V}$ | $I_{c} = 10 \text{ A},$ | T _J = 175°C | 0.8 | 1.05 | 1.4 | |
| | | | | | | | · | | T _J = -40°C | 1.0 | 1.2 | 1.7* | | |
| | | | T _J = 25°C | 1.0 | 1.3 | 1.7 | | | | | | | | |
| | | $I_{c} = 15 \text{ A},$ $V_{GE} = 4.5 \text{ V}$ | T _J = 175°C | 1.0 | 1.3 | 1.55 | | | | | | | | |
| | | V _{GE} − 4.5 V | T _J = -40°C | 1.1 | 1.35 | 1.8* | 1 | | | | | | | |
| | | $I_{c} = 20 \text{ A},$ $V_{GE} = 4.5 \text{ V}$ | T _J = 25°C | 1.3 | 1.6 | 1.9 | | | | | | | | |
| | | | T _J = 175°C | 1.2 | 1.5 | 1.8 | | | | | | | | |
| | | v _{GE} – 4.5 v | T _J = -40°C | 1.4 | 1.75 | 2.0* | | | | | | | | |
| Forward Transconductance | gfs | $V_{CE} = 5.0 \text{ V},$ $I_{C} = 6.0 \text{ A}$ | T _J = 25°C | 10 | 18 | 25 | Mhos | | | | | | | |

 $^{{\}rm *Maximum\,Value\,\,of\,\,Characteristic\,\,across\,Temperature\,\,Range}.$

^{3.} Pulse Test: Pulse Width $\leq 300~\mu\text{S},~\text{Duty Cycle} \leq 2\,\%$.



Dynamic Characteristics

| Characteristic | Symbol | Test Conditions | Temperature | Min | Тур | Max | Unit |
|----------------------|------------------|--------------------------------|-----------------------|------|------|------|------|
| Input Capacitance | C _{ISS} | | | 1100 | 1300 | 1500 | |
| Output Capacitance | C _{oss} | $V_{CE} = 25 V$ f = 10 kHz | T _J = 25°C | 70 | 80 | 90 | pF |
| Transfer Capacitance | C _{RSS} | | | 18 | 20 | 22 | |

Switching Characteristics

| Characteristic | Symbol | Test Conditions | Temperature | Min | Тур | Max | Unit |
|---------------------|----------------------|---|------------------------|-----|------|-----|------|
| Turn-Off Delay Time | + | V _{cc} = 300 V, | T _J = 25°C | 6.0 | 8.0 | 10 | |
| (Resistive) | t _{d (off)} | $I_{c} = 9 A$ $R_{G} = 1.0 k\Omega,$ | T _J = 175°C | 6.0 | 8.0 | 10 | |
| Fall Time | | $R_L = 33 \Omega,$ $V_{GE} = 5.0 V$ | T _J = 25°C | 4.0 | 6.0 | 8.0 | |
| (Resistive) | t _f | | T _J = 175°C | 8.0 | 10.5 | 14 | |
| Turn-Off Delay Time | _ | | T _J = 25°C | 3.0 | 5.0 | 7.0 | |
| (Inductive) | t _{d (off)} | $V_{cc} = 300 \text{ V},$ $I_{c} = 9 \text{ A}$ | T _J = 175°C | 5.0 | 7.0 | 9.0 | |
| Fall Time | | $R_G = 1.0 \text{ k}\Omega$, L = 300 μH, $V_{GF} = 5.0 \text{ V}$ | T _J = 25°C | 1.5 | 3.0 | 4.5 | μSec |
| (Inductive) | t _f | v _{GE} = 3.0 v | T _J = 175°C | 5.0 | 7.0 | 10 | |
| Torra On Dalay Time | _ | | T _J = 25°C | 1.0 | 1.5 | 2.0 | |
| Turn-On Delay Time | t _{d (on)} | $V_{CC} = 14 \text{ V},$ $I_{C} = 9.0 \text{ A}$ | T _J = 175°C | 1.0 | 1.5 | 2.0 | |
| Die Tier | _ | $R_G = 1.0 \text{ k}\Omega,$ $R_L = 1.5 \Omega,$ $V_{GE} = 5.0 \text{ V}$ | T _J = 25°C | 4.0 | 6.0 | 8.0 | |
| Rise Time | t _r | V _{GE} — 5.5 V | T _J = 175°C | 3.0 | 5.0 | 7.0 | |

^{2.} Pulse Test: Pulse Width $\leq 300~\mu\text{S},~\text{Duty Cycle} \leq 2\,\%\,.$

^{*}Maximum Value of Characteristic across Temperature Range.



Ratings and Characteristic Curves

Figure 1. Self Clamped Inductive Switching

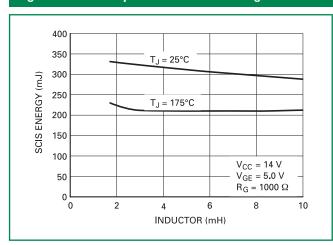


Figure 2. Open Secondary Avalanche Current vs. Temperature

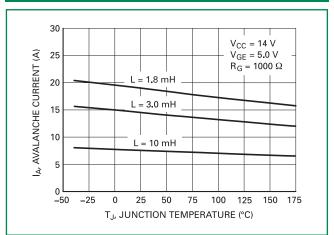


Figure 3. Collector-to-Emitter Voltage vs. Junction Temperature

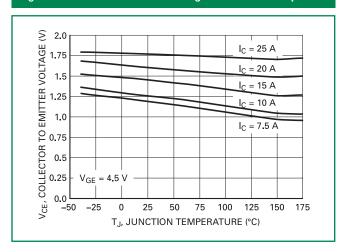


Figure 4. Collector Current vs. Collector-to-Emitter Voltage

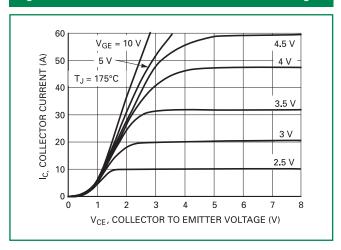


Figure 5. Collector Current vs. Collector-to-Emitter Voltage

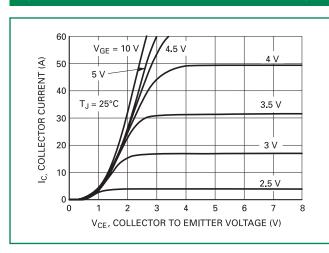


Figure 6. Collector Current vs. Collector-to-Emitter Voltage

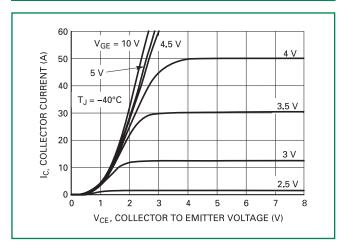




Figure 7. Transfer Characteristics

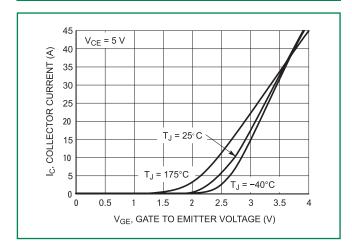


Figure 8. Collector-to-Emitter Leakage Current vs. Temperature

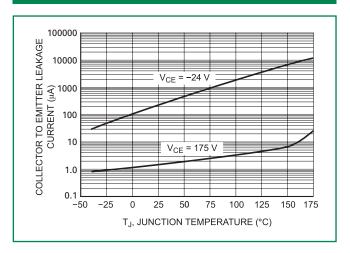


Figure 9. Gate Threshold Voltage vs. Temperature

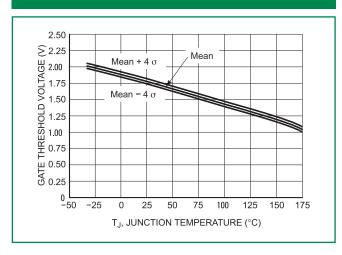


Figure 10. Capacitance vs. Collector-to-Emitter Voltage

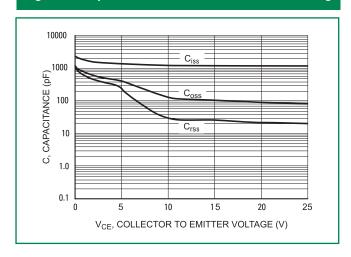


Figure 11. Resistive Switching Fall Time vs. Temperature

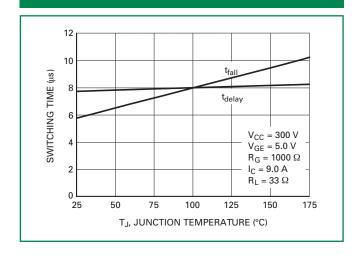


Figure 12. Inductive Switching Fall Time vs. Temperature

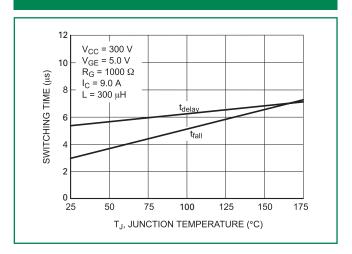
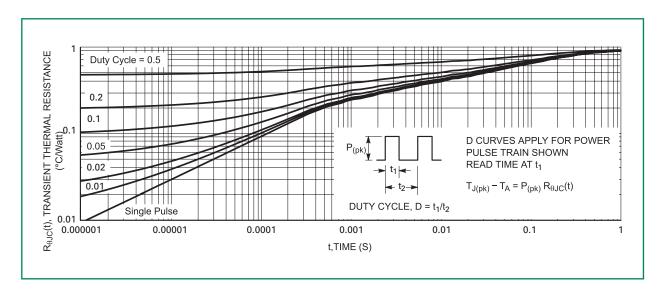


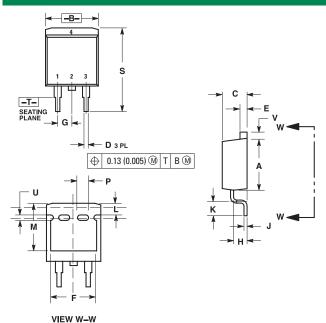


Figure 13. Minimum Pad Transient Thermal Resistance (Non-normalized Junction-to-Ambient)





Dimensions

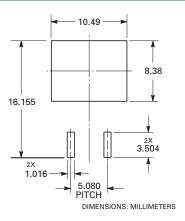


| | Inc | hes | Millim | neters |
|-----|-----------|-------|----------|--------|
| Dim | Min | Max | Min | Max |
| А | 0.340 | 0.380 | 8.64 | 9.65 |
| В | 0.380 | 0.405 | 9.65 | 10.29 |
| С | 0.160 | 0.190 | 4.06 | 4.83 |
| D | 0.020 | 0.035 | 0.51 | 0.89 |
| Е | 0.045 | 0.055 | 1.14 | 1.40 |
| F | 0.310 | 0.350 | 7.87 | 8.89 |
| G | 0.100 | BSC | 2.54 BSC | |
| Н | 0.080 | 0.110 | 2.03 | 2.79 |
| J | 0.018 | 0.025 | 0.46 | 0.64 |
| K | 0.090 | 0.110 | 2.29 | 2.79 |
| L | 0.052 | 0.072 | 1.32 | 1.83 |
| М | 0.280 | 0.320 | 7.11 | 8.13 |
| N | 0.197 | REF | 5.00 REF | |
| Р | 0.079 REF | | 2.00 REF | |
| R | 0.039 REF | | 0.99 REF | |
| S | 0.575 | 0.625 | 14.60 | 15.88 |
| V | 0.045 | 0.055 | 1.14 | 1.40 |

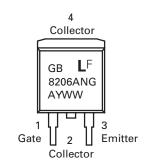
NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH.
- 3. 418B-01 THRU 418B-03 OBSOLETE, NEW STANDARD 418B-04.

Soldering Footrpint



Part Marking System



GB8206AN = Device Code

 $\begin{array}{ll} \mathsf{A} = & \mathsf{Assembly\ Location} \\ \mathsf{Y} = & \mathsf{Year} \\ \mathsf{WW} & = \mathsf{Work\ Week} \\ \mathsf{G} & = \mathsf{Pb}\text{-}\mathsf{Free\ Package} \end{array}$

ORDERING INFORMATION

| Device | Package | Shipping |
|---------------|--------------------|----------------------|
| NGB8206ANT4G | D ² PAK | 800 / Tape & Reel |
| NGB8206ANTF4G | (Pb-Free) | 700 / Tape & Reel |
| NGB8206ANSL3G | | 50 Units / Rail |

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RJH60F3DPQ-A0#T0 APT40GR120B2SCD10 APT15GT120BRG APT20GT60BRG NGTB75N65FL2WAG NGTG15N120FL2WG
IXA30RG1200DHGLB IXA40RG1200DHGLB APT70GR65B2DU40 NTE3320 QP12W05S-37A IHFW40N65R5SXKSA1 APT70GR120J
APT35GP120JDQ2 IKZA40N65RH5XKSA1 IKFW75N65ES5XKSA1 IKFW50N65ES5XKSA1 IKFW50N65EH5XKSA1
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XD25H120CX0 XP15PJS120CL1B1 IGW30N60H3FKSA1 STGWA8M120DF3 IGW08T120FKSA1 IGW75N60H3FKSA1
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IKP20N60TXKSA1 IHW20N65R5XKSA1